



SamHop Microelectronics Corp.



STU/D9916L

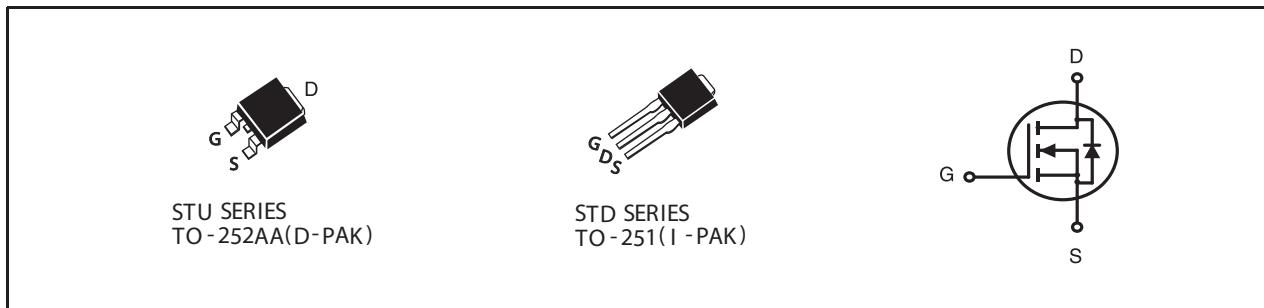
Ver 1.2

## N-Channel Logic Level Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (mΩ) Max
30V	25A	25 @ VGS=10V
		35 @ VGS=4.5V

### FEATURES

- Super high dense cell design for low RDS(ON).
- Rugged and reliable.
- TO-252 and TO-251 Package.



### ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current-Continuous <sup>a</sup>	$T_C=25^\circ\text{C}$	A
		$T_C=70^\circ\text{C}$	A
$I_{DM}$	-Pulsed <sup>b</sup>	63	A
$P_D$	Maximum Power Dissipation <sup>a</sup>	$T_C=25^\circ\text{C}$	W
		$T_C=70^\circ\text{C}$	W
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 to 150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case <sup>a</sup>	3	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient <sup>a</sup>	50	$^\circ\text{C/W}$

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## ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>OFF CHARACTERISTICS</b>						
BVDSS	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30			V
IDS <sub>S</sub>	Zero Gate Voltage Drain Current	$V_{DS}=24V, V_{GS}=0V$			1	$\mu A$
IGSS	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	$nA$
<b>ON CHARACTERISTICS</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.7	1.5	2.0	V
R <sub>DSON</sub>	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=20A$		15	25	m ohm
		$V_{GS}=4.5V, I_D=20A$		25	35	m ohm
g <sub>FS</sub>	Forward Transconductance	$V_{DS}=10V, I_D=20A$		10		S
<b>DYNAMIC CHARACTERISTICS <sup>c</sup></b>						
C <sub>ISS</sub>	Input Capacitance	$V_{DS}=25V, V_{GS}=0V$ $f=1.0MHz$		570	720	pF
C <sub>OSS</sub>	Output Capacitance			93	117	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance			74	92	pF
<b>SWITCHING CHARACTERISTICS <sup>c</sup></b>						
t <sub>D(ON)</sub>	Turn-On Delay Time	$V_{DD}=15V$ $I_D=1A$ $V_{GS}=10V$ $R_{GEN}= 11 \text{ ohm}$		10.5	12.9	ns
t <sub>r</sub>	Rise Time			14.3	17.8	ns
t <sub>D(OFF)</sub>	Turn-Off Delay Time			20	25	ns
t <sub>f</sub>	Fall Time			22.1	27.6	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS}=15V, I_D=20A, V_{GS}=10V$		11	13.7	nC
		$V_{DS}=15V, I_D=20A, V_{GS}=4.5V$		5.5	6.8	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{DS}=15V, I_D=20A,$ $V_{GS}=10V$		1.2	1.5	nC
Q <sub>gd</sub>	Gate-Drain Charge			3.4	4	nC
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
V <sub>SD</sub>	Diode Forward Voltage <sup>b</sup>	$V_{GS}=0V, I_S=15A$		1	1.3	V
<b>Notes</b>						
a.Surface Mounted on FR4 Board, $t \leq 10\text{sec}$ .						
b.Pulse Test:Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ .						
c.Guaranteed by design, not subject to production testing.						

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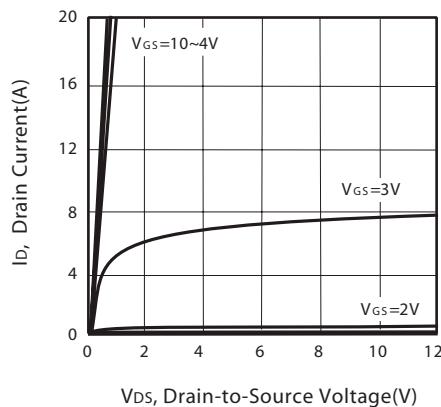


Figure 1. Output Characteristics

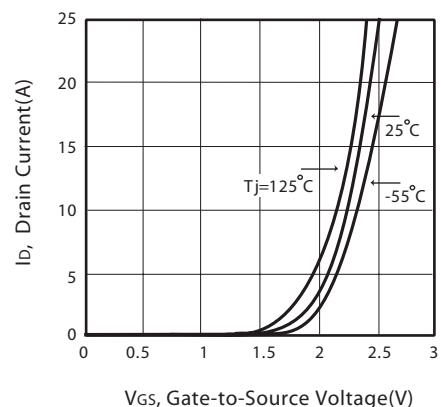


Figure 2. Transfer Characteristics

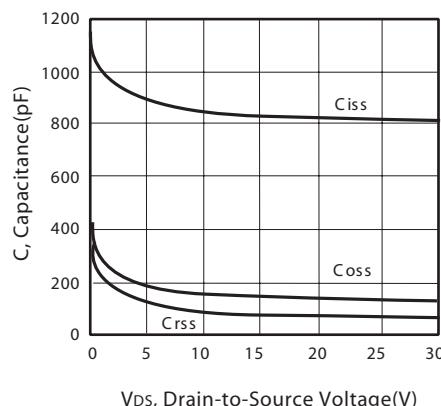


Figure 3. Capacitance

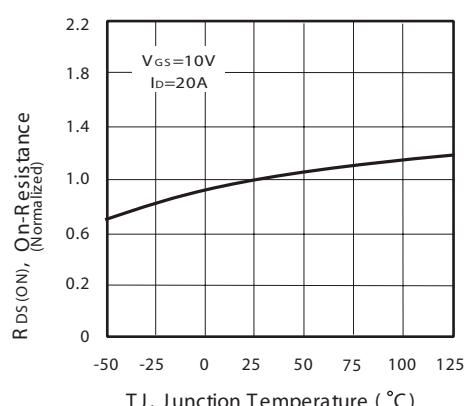


Figure 4. On-R Resistance Variation with Temperature

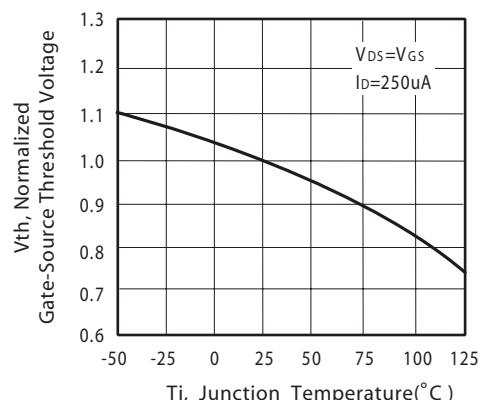


Figure 5. Gate Threshold Variation with Temperature

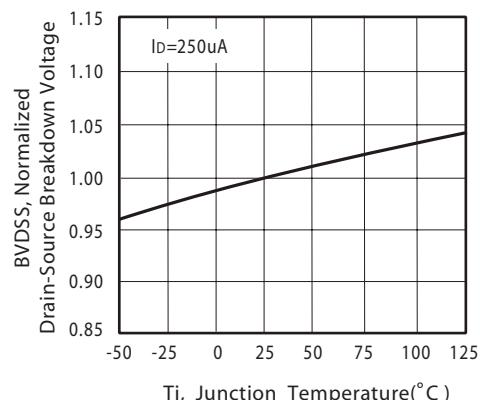


Figure 6. Breakdown Voltage Variation with Temperature

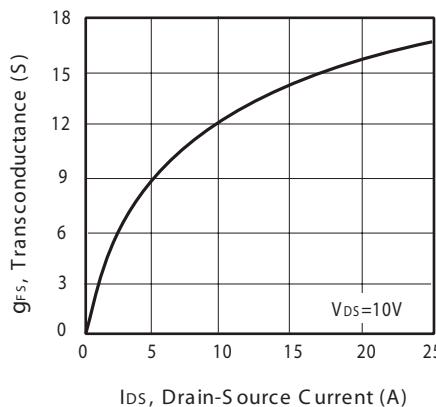


Figure 7. Transconductance Variation with Drain Current

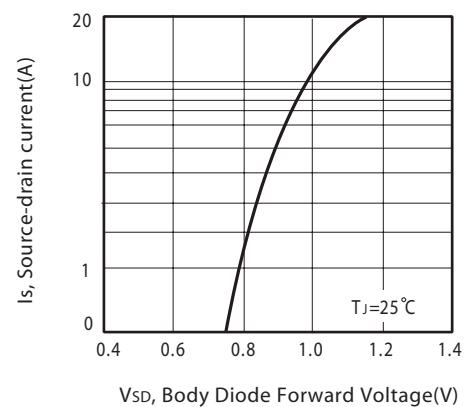


Figure 8. Body Diode Forward Voltage Variation with Source Current

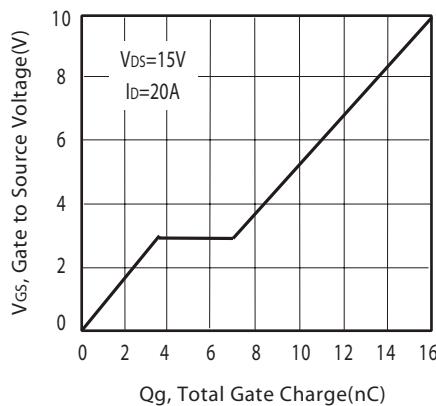


Figure 9. Gate Charge

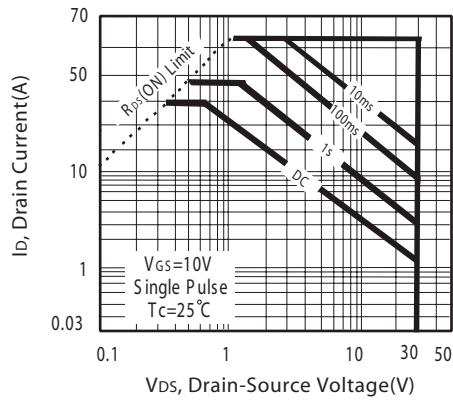


Figure 10. Maximum Safe Operating Area

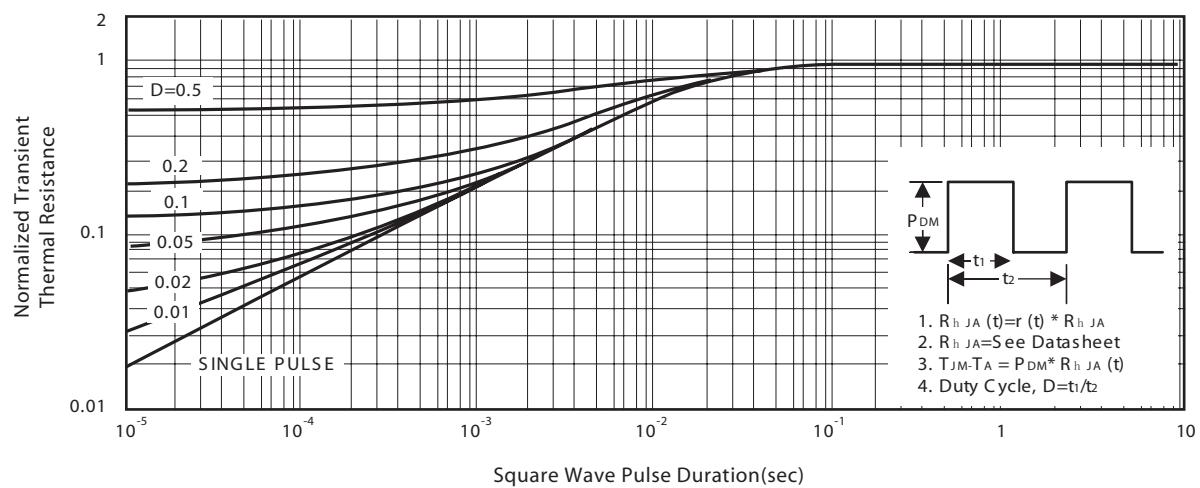


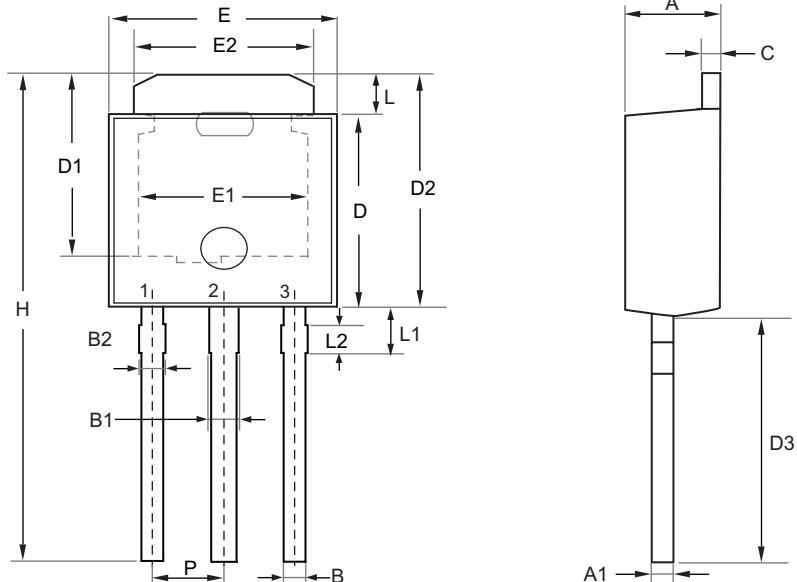
Figure 11. Normalized Thermal Transient Impedance Curve

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## PACKAGE OUTLINE DIMENSIONS

TO-251

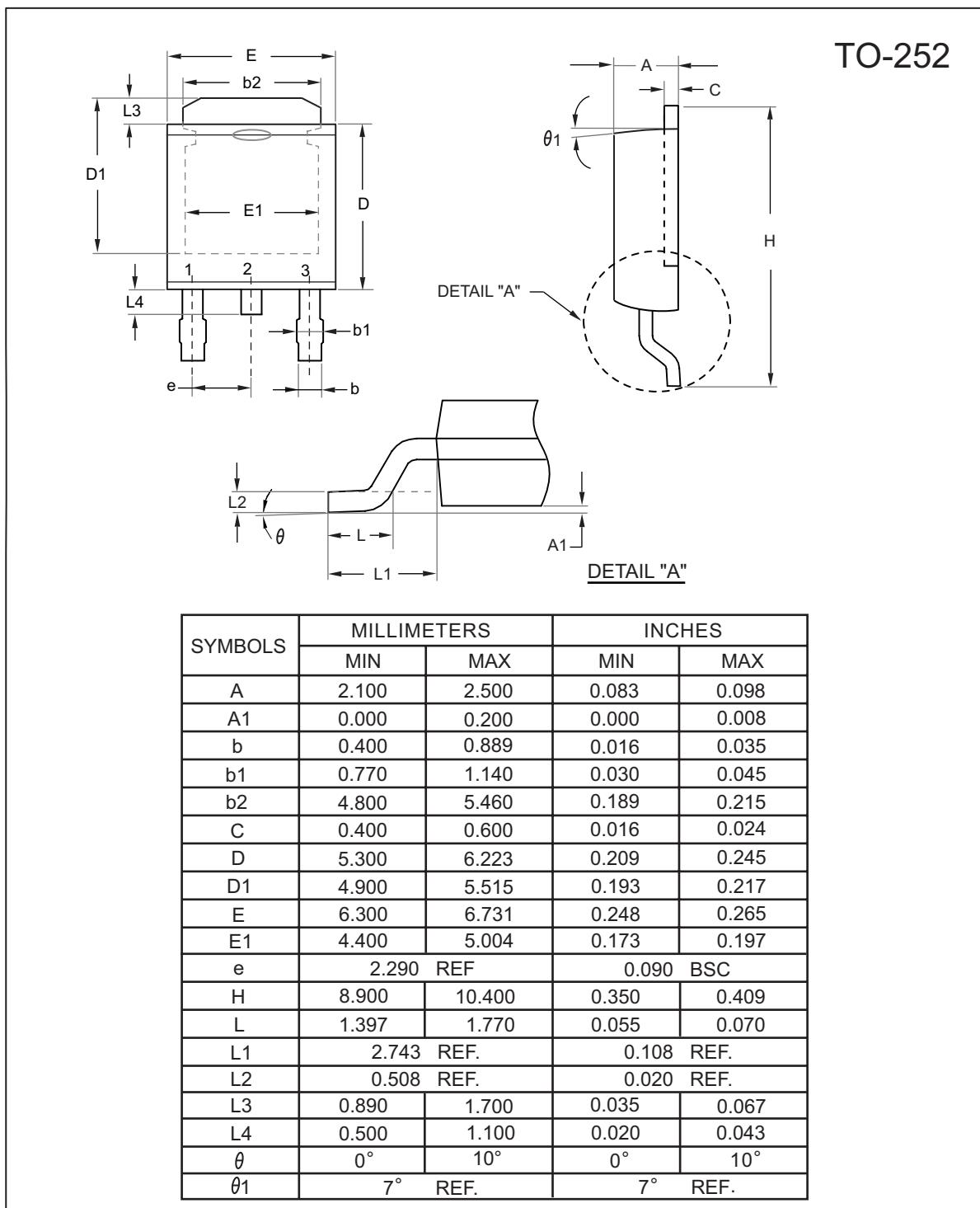


SYMBOL	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.100	2.500	0.083	0.098
A1	0.350	0.650	0.014	0.026
B	0.400	0.800	0.016	0.031
B1	0.650	1.050	0.026	0.041
B2	0.500	0.900	0.020	0.035
C	0.400	0.600	0.016	0.024
D	5.300	5.700	0.209	0.224
D1	4.900	5.300	0.193	0.209
D2	6.700	7.300	0.264	0.287
D3	7.000	8.000	0.276	0.315
H	13.700	15.300	0.539	0.602
E	6.300	6.700	0.248	0.264
E1	4.600	4.900	0.181	0.193
E2	4.800	5.200	0.189	0.205
L	1.300	1.700	0.051	0.067
L1	1.400	1.800	0.055	0.071
L2	0.500	0.900	0.020	0.035
P	2.300 BSC		0.091 BSC	

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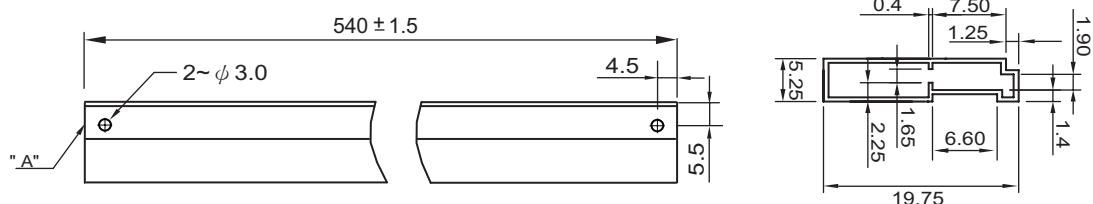
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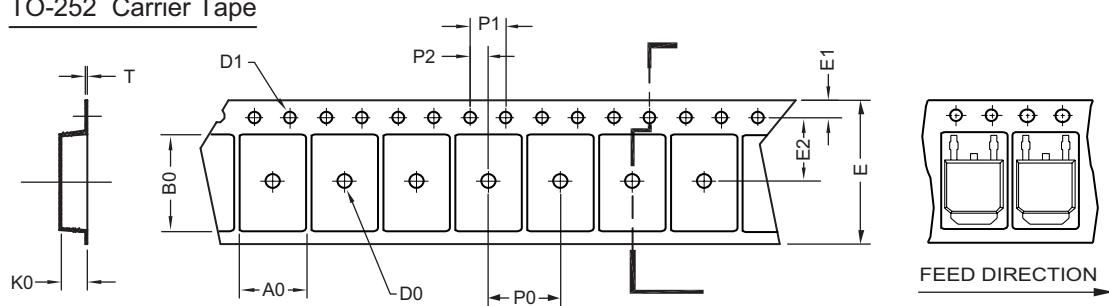
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## TO-251 Tube/TO-252 Tape and Reel Data

### TO-251 Tube



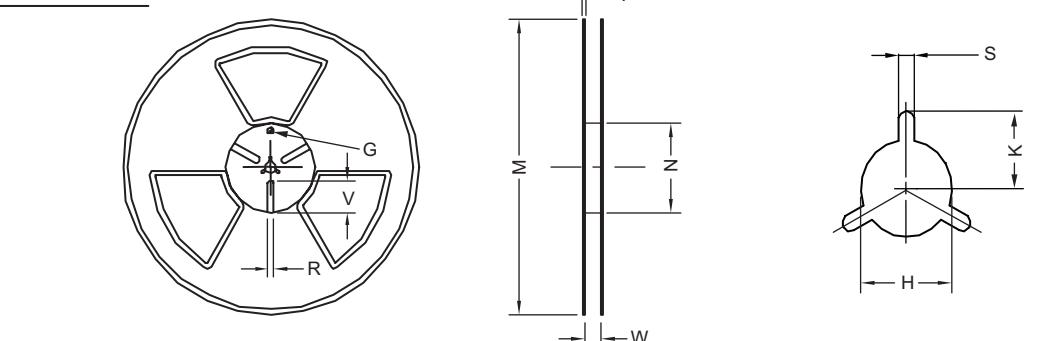
### TO-252 Carrier Tape



UNIT:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
TO-252 (16 mm)	6.96 ±0.1	10.49 ±0.1	2.79 ±0.1	ψ 2	ψ 1.5 + 0.1 - 0	16.0 ±0.3	1.75 ±0.1	7.5 ±0.15	8.0 ±0.1	4.0 ±0.1	2.0 ±0.15	0.3 ±0.05

### TO-252 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	T	H	K	S	G	R	V
16 mm	ψ 330	ψ 330 ± 0.5	ψ 97 ± 1.0	17.0 + 1.5 - 0	2.2	ψ 13.0 + 0.5 - 0.2	10.6	2.0 ± 0.5	---	---	---